Effect of GaN substrate thickness on the optical field of InGaN laser diodes

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In this work the influence of GaN substrate thickness on the near and far-field patterns of InGaN lasers structures is numerically studied. In simulation a typical structure with an InGaN-MQW active region, GaN waveguide and Al$_x$Ga$_{1-x}$N cladding layers is considered. A fluctuating behavior was obtained showing that for some values of the substrate thickness the near and far-field patterns can be optimized, while there are critical values that significantly reduce the confinement factor and widen the far field patterns. It is also shown that, replacing the n-GaN contact layer by a graded-index (GRIN) Al$_x$Ga$_{1-x}$N layer can help reduce the optical field leakage to substrate. Simulation results indicate that properly choosing the thickness of the substrate and using a GRIN n-Al$_x$Ga$_{1-x}$N contact layer it is possible to improve both the confinement factor and far field patterns in nitride lasers.

Keywords: Optical field leakage; numerical simulation; InGaN laser diodes; GaN substrates.

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1. Introduction

Group-III nitride laser diodes (LDs) commercially available since 2000 are nowadays used in a wide range of applications such as: optical data storage, printing and photolithography [1,2], but in spite of their great success, these devices still suffer from various problems and are far from being optimized. One of the unsolved problems is the leakage of optical field to the substrate by the insufficient optical confinement. This is due to the difficulty to growth the thick AlGaN cladding layers with high aluminum content needed to ensure an efficient waveguide [3-5]. The leakage of the optical field affects the beam shape which is critical in applications such as data storage and laser projection.

On the other hand the presence of GaN contact layers with larger refractive index compared to AlGaN cladding layers causes an anti-guide effect in the optical cavity of the structure [6]. As a result, high order modes in the waveguide occur, affecting both the near and far field patterns [7].

Another problem in fabrication of nitrides based LDs is the lack of native GaN substrates. Presently InGaN based LDs are grown onto sapphire or SiC substrates [8]. This results in high threading dislocation densities in the structure because of thermal and lattice mismatch [9,10].

Recently GaN substrates have been used to growth LD structures [11,12] but this aggravates the problem of the optical field leakage to substrate as illustrated in the experimental works of T. Swietlik et al. [13] and J. Dorsaz et al. [12]. In this case the anti-guide effect is more pronounced since the GaN substrate layer is added to the n-GaN contact layer resulting in a much thicker layer of higher refractive index than the cladding layer.

Studies of InGaN LDs grown onto sapphire substrates shown that the detrimental effects produced by the anti-guide problem on the, confinement factor, near-field patterns (NFPs) and far field patterns (FFPs) can be minimized by properly choosing the thickness and composition of the different layers forming the heterostructures [14-16].

To fabricate efficient waveguides with not optical leakage, very thick claddings layers are usually grown in arsenide-based lasers. Unfortunately, in case of nitride material system, there is a significant lattice mismatch between AlN and GaN [8], which strongly limits the thickness attainable in the AlGaN cladding layers. AlGaN layers thicker than the critical thickness tend to crack and the stress introduced in the Al$_x$Ga$_{1-x}$N cladding layers results in poor quality material [7,17].

Owing to the limitation in the thickness of the AlGaN layer can be growth; different approaches have been proposed to reduce the leakage of the optical modes to the substrate. Recently Muziol et al proposed a design in which the leakage has been fully suppressed by using a high-indium-content thick InGaN waveguide [18].

In this work we analyze the influence of GaN substrate thickness on the optical confinement factor, near and far field patterns in InGaN lasers. Simulation was done replacing the n-GaN contact layer by an n-Al$_x$Ga$_{1-x}$N grading layer (0 ≤ x ≤ 0.15). It is shown that appropriately choosing the thickness of the substrate and replacing the n-GaN contact layer by a GRIN-Al$_x$Ga$_{1-x}$N layer it is possible to enhance the optical confinement factor and decrease the full wide half-maximum (FWHM) of the far field pattern.

2. Laser diode structure and parameters used in simulation

A schematic of the laser structure used in simulations is shown in Fig. 1. It is a separate confinement optical cavity
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TABLE I. Layer structure and physical parameters used in simulation.

<table>
<thead>
<tr>
<th>Layer</th>
<th>refractive index</th>
<th>thickness</th>
</tr>
</thead>
<tbody>
<tr>
<td>p-contact</td>
<td>0.9</td>
<td>2.5</td>
</tr>
<tr>
<td>p-GaN contact</td>
<td>2.537</td>
<td>0</td>
</tr>
<tr>
<td>p-Al_{0.15}Ga_{0.85}N cladding</td>
<td>2.456</td>
<td>0</td>
</tr>
<tr>
<td>p-GaN guide</td>
<td>2.537</td>
<td>0</td>
</tr>
<tr>
<td>p-Al_{0.2}Ga_{0.8}N (EBL)</td>
<td>2.434</td>
<td>0</td>
</tr>
<tr>
<td>2 QW’s active</td>
<td></td>
<td></td>
</tr>
<tr>
<td>In_{0.15}Ga_{0.85}N well</td>
<td>2.625</td>
<td>0</td>
</tr>
<tr>
<td>In_{0.05}Ga_{0.95}N barrier</td>
<td>2.553</td>
<td>0</td>
</tr>
<tr>
<td>n-GaN guide</td>
<td>2.537</td>
<td>0</td>
</tr>
<tr>
<td>n-Al_{0.15}Ga_{0.85}N cladding</td>
<td>2.456</td>
<td>0</td>
</tr>
<tr>
<td>n-GaN contact</td>
<td>2.537</td>
<td>0</td>
</tr>
<tr>
<td>GaN substrate</td>
<td>2.537</td>
<td>0</td>
</tr>
<tr>
<td>n-Au contact</td>
<td>1.561</td>
<td>1.828</td>
</tr>
</tbody>
</table>

3. Calculation

The scalar wave equation of the fields was used to calculate the confined modes in the waveguide:

\[
\frac{d^2\Psi}{dx^2} + [k_0^2 n^2(x) - \beta_m^2]\Psi = 0 \quad (1)
\]

Here, \(\Psi\) is the transverse component of the electric \(E\) or magnetic field \(H\), \(k_0 = 2\pi/\lambda_0\) is the free space vector, \(n(x)\) is the complex refractive index profile in the laser structure, \(\beta_m = k_0N_m\) is the propagation constant and \(N_m\) the effective refractive index of the mode \(m\). We have taken the solution in the \(z\)-direction and in the time domain in the form \(\exp[i(\beta z - wt)]\).

The Runge-Kutta-Nystrom method was used to obtain the numerical solution in the GRIN-layer since Eq. 1 has not an exact solution in this layer. In the rest of the layers the exact solutions of the wave equation were obtained as was done in Ref. 21.

From the relation between the magnetic component \(Hz\) and the electric field component \(Ey\), we get the appropriate boundary conditions at the different interfaces to obtain a complete solution of the problem [22]. The dispersion law was obtained by using the transfer matrix method. The solution of the dispersion equation was found using the method of testing for transcendental equations. From these solutions the effective refractive index of the fundamental mode \(No\) was obtained. The near field \(\Psi(x)\) was calculated taking into account all layers in the heterostructure, except for the Au electrodes. These metallic layers were considered of infinite thickness because of the great difference between its refractive index and that of the surrounding layers (see Table I).

The confinement factor (\(\Gamma\)) is defined as the ratio of the light intensity within the active region to the sum of the total

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light intensity within and outside the active layer [22], and is given by:

\[
\Gamma = \frac{\int_{\text{MQW}} \Psi^2(x) dx}{\int_{-\infty}^{+\infty} \Psi^2(x) dx}
\]

(2)

Notice that in a MQW structure the confinement factor is given by the summation of the value of the confinement factor for each QW. The confinement factor tells about the extent to which an optical mode is confined to the active region so is desirable to have the greatest possible value of this parameter for a good laser performance.

The far-field pattern perpendicular to the junction plane of the laser structure is the product of the Fourier transform of the near field \(\Psi(x)\) and an obliquity factor. The far field

\begin{figure}[h]
\centering
\includegraphics[width=\columnwidth]{figure2}
\caption{Calculated near and far field (inset) intensity patterns for 3 \(\mu\)m thick GaN substrate. Values of the confinement factor and FWHM are also shown. In this case the near field pattern is smooth indicating a good optical confinement and that there is almost no leakage of the optical field into the substrate.}
\end{figure}

\begin{figure}[h]
\centering
\includegraphics[width=\columnwidth]{figure3}
\caption{Calculated near and far field (inset) intensity patterns for 13 \(\mu\)m thick GaN substrate. Values of the confinement factor and FWHM are also shown. In this case the near field pattern has many ripples, resulting in pronounced peaks at both sides of the central maximum in the far-field pattern. This result indicates that for this value of the substrate thickness the optical leakage into substrate is remarkable.}
\end{figure}

\begin{figure}[h]
\centering
\includegraphics[width=\columnwidth]{figure4}
\caption{Calculated near and far field (insert) intensity patterns for a 36 \(\mu\)m thick GaN substrate. In this case and contrary to what you would expect, results are very similar to those of the Fig. 2 indicating this substrate value provides an efficient optical waveguide.}
\end{figure}

\begin{figure}[h]
\centering
\includegraphics[width=\columnwidth]{figure5}
\caption{Calculated near and far field (insert) intensity patterns for a 50 \(\mu\)m thick GaN substrate. In this case a very low value of the confinement factor is obtained; again ripples in the near field pattern appear indicating the leakage of optical modes to GaN substrate.}
\end{figure}

\begin{figure}[h]
\centering
\includegraphics[width=\columnwidth]{figure6}
\caption{Calculated near and far field (insert) intensity patterns for a 100 \(\mu\)m thick GaN substrate. Here although the thickness of the substrate is double of that in previous figure, the confinement factor and the far and near field patterns improve and the optical leakage is reduced. This result proves the fluctuating behavior of theses parameters regarding the substrate thickness.}
\end{figure}
intensity at the angle $\theta$ relative to the intensity at $\theta = 0$ is given by [22]:

$$\frac{I(\theta)}{I(0)} = \frac{\cos^2 \theta \left| \int_{-\infty}^{+\infty} \Psi(x) \exp(ik_0 x \sin \theta) dx \right|^2}{\left| \int_{-\infty}^{+\infty} \Psi(x) dx \right|^2}$$

(3)

4. Results and Discussion

The effect of the GaN substrate thickness on the confinement factor, near and far field patterns in nitride laser was numerically simulated. The values of the refractive index used for calculation are taken at the wavelength of 410 nm, the emission wavelength reported for our experimental reference device.

Figures 2 to 6 show the impact of substrate thickness on the confinement factor and near field patterns. In all cases Al$_{0.15}$Ga$_{0.85}$N claddings and n-GaN contact layer are set to 2 and 0.7 $\mu$m respectively. The insets show the resultant far field pattern and the full wide at half-maximum (FWHM) values in each case. The substrate thickness was changed from 1 to 100 $\mu$m. It is important to point out that currently available GaN substrates have a small thickness. There are no GaN ingots as those of silicon and GaAs, so costly, free-standing substrates are obtained by growing a GaN layer onto other substrates and then cut into wafers. Typically GaN substrates from 3 to 8 microns are obtained [5].

As can be seen from these figures and contrary to what might be expected, the near field pattern and the confinement

**Figure 7.** Substrate thickness dependence of $\Gamma$ and FWHM for a Al$_{0.15}$Ga$_{0.85}$N cladding layer of 0.7 $\mu$m.

**Figure 8.** Substrate thickness dependence of $\Gamma$ and FWHM for a 1 $\mu$m Al$_{0.15}$Ga$_{0.85}$N cladding layer.
factor do not worsen in a continuously way as the thickness of the substrate is increased. Instead a fluctuating behavior is observed and there are specific values for which highest values of the confinement factor and lowest values of the FWHM are obtained. For example for a substrate thickness of 13 $\mu$m the near field pattern has many ripples and two pronounced peaks at both sides of the central maximum can be observed in the resulting far-field pattern. However, for a substrate thickness of 36 $\mu$m the parasitic ripples on the NFP almost disappeared and the peaks on the far field pattern are significantly reduced.

In Fig. 7, the confinement factor and FWHM values obtained for substrate thickness from 1 to 50 $\mu$m are shown. Here the oscillating behavior of the confinement factor and the FWHM can be noticed in more detail. These results show there are critical values of the substrate’s thickness for which $\Gamma$ reaches its minimum value and FWHM a maximum value which should not be used. We can also observe how these critical points get closer as the substrate thickness increases, becoming practically a continuous for very thick substrates. In particular for a substrate thicker than 43 $\mu$m the FWHM can no longer be reduced but remains around a constant value of 50 deg. So it is not recommended to exceed this thickness since values of the FWHM as low as possible are desirable for practical applications.

The number of critical points can be reduced by using thicker cladding layers as it is shown in Figs. 8 and 9. These figures show the dependence of $\Gamma$ and FWHM with the substrate thickness for cladding layers of 0.7 and 1.5 $\mu$m respectively. Notice that the critical points come closer to each other as the width of the substrate is increased.

For a cladding layer thickness of 1.5 $\mu$m, no fluctuation in $\Gamma$ or the FWHM is observed when substrate thickness is below 24 $\mu$m. This is because the thick cladding layer prevents the penetration of the optical modes into the substrate.

Figure 10 shows that the same effect can be obtained by replacing the n-GaN contact layer with a GRIN Al$_x$Ga$_{1-x}$N layer. The NFP and FFP patterns obtained for a 2 $\mu$m-n-Al$_x$Ga$_{1-x}$N layer with a parabolic variation of Al composition from 0 to 0.15 are shown. Simulation was done for a substrate of 100 $\mu$m and a 0.7 $\mu$m Al$_{0.15}$Ga$_{0.85}$N cladding layer. No ripples in the NFP are observed and a Gaussian-shaped far-field pattern is obtained in this case.

Figure 11 shows the dependence of $\Gamma$ and the FWHM on the substrate’s thickness for 0.7 $\mu$m Al$_{0.15}$Ga$_{0.85}$N cladding layers and a 2 $\mu$m GRIN-contact layer. It can be observed that the behavior of $\Gamma$ and the FWHM is similar to that achieved when a 1 $\mu$m Al$_{0.15}$Ga$_{0.85}$N cladding layer is used as was shown in Fig. 7. This result demonstrate that the use of a graded Al$_x$Ga$_{1-x}$N contact layer instead of the typical n-GaN layer, leads to an improvement of the optical beam
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Figure 11. Dependence of $\Gamma$ and FWHM on substrate thickness for $0.7\,\mu m$ Al$_{0.15}$Ga$_{0.85}$N cladding layers and $2\,\mu m$ n-Al$_x$Ga$_{1-x}$N ($0 \leq x \leq 0.15$) GRIN contact layer.

and can be an alternative to the impediment to growth thick Al$_{0.15}$Ga$_{0.85}$N cladding layers.

Finally the dependence of $\Gamma$ and the FWHM with the width of the GRIN Al$_x$Ga$_{1-x}$N contact layer is analyzed and results are shown in Fig. 12. The GaN substrate and

Figure 12. Dependence of $\Gamma$ and FWHM on the n-Al$_x$Ga$_{1-x}$N GRIN layer thickness for a $100\,\mu m$ GaN substrate and $0.7\,\mu m$ Al$_{0.15}$Ga$_{0.85}$N cladding layers.

Al$_{0.15}$Ga$_{0.85}$N cladding layers are $100\,\mu m$ and $0.7\,\mu m$ respectively and GRIN layer thickness varied from 1 to 6 $\mu m$.

Simulation results reveal there are substrates thicknesses for which the optical field accommodates better in the waveguide with a less penetration in the anti-guides, resulting in a high value of the confinement factor, and a low value of the FWHM of the far field pattern, as desired. Also observed is the existence of critical points for which $\Gamma$ has very low values and the FWHM has high values and should be avoided in the structure design. Finally the replacement of the GaN contact layer by a GRIN Al$_x$Ga$_{1-x}$N could be a solution to the problem of growing thick cladding layers.

5. Conclusions

In this paper, we have analyzed the effect of the GaN substrate thickness on the optical field in InGaN laser diodes. Near and far-field patterns perpendicular to the junction plane were calculated by solving the wave equation. Results revealed a fluctuating behavior, for some values of the substrate thickness the NFPs and FFPs can be optimized and the optical field leakage towards the substrate is substantially reduced. Also, there are critical values of the substrate thickness that produce the lowest values of the confinement factor and the higher values for the FWHM which should be avoided. These results indicating that the thickness of GaN substrate is a critical parameter in the design of the optical cavity in nitrides lasers. It is shown that appropriately choosing the thickness of the substrate and replacing the n-GaN contact layer by a GRIN-Al$_x$Ga$_{1-x}$N layer it is possible to improve both the confinement factor and Far field pattern in nitride lasers and the performance of the InGaN quantum-well lasers can be enhanced.

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